

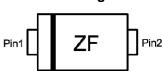


Description

The PESDNC5D5VU protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. They feature large cross-sectional area junctions for conducting high transient currents, offer desirable electrical characteristics for board level protection, such as fast response time, low operating voltage. It gives designer the flexibility to protect one unidirectional line in applications where arrays are not practical.



Circuit Diagram



Marking (Top View)

Feature

- \geq 200W peak pulse power per line (t_P = 8/20µs)
- SOD-523 package
- Replacement for MLV(0603)
- Unidirectional configurations
- Response time is typically < 1 ns</p>
- Protect one I/O or power line
- Low clamping voltage
- RoHS compliant
- Transient protection for data lines to IEC 61000-4-2(ESD)
 ±30KV(air), ±30KV(contact); IEC 61000-4-4 (EFT) 40A (5/50ns)

Applications

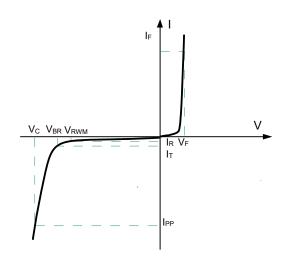
- Cellular phones
- Portable devices
- Digital cameras
- Power supplies

Mechanical Characteristics

- Lead finish:100% matte Sn(Tin)
- Mounting position: Any
- Qualified max reflow temperature:260°C
- Device meets MSL 1 requirements
- ➤ Pure tin plating: 7 ~ 17 um
- Pin flatness:≤3mil

Electronics Parameter

| Symbol | Parameter | |
|-----------------|--|--|
| V_{RWM} | Peak Reverse Working Voltage | |
| I_R | Reverse Leakage Current @ V _{RWM} | |
| V_{BR} | Breakdown Voltage @ I⊤ | |
| lτ | Test Current | |
| I _{PP} | Maximum Reverse Peak Pulse Current | |
| Vc | Clamping Voltage @ IPP | |
| P _{PP} | Peak Pulse Power | |
| Сл | CJ Junction Capacitance IF Forward Current VF Forward Voltage @ IF | |
| lF | | |
| V _F | | |



Absolute maximum rating@25℃

| Rating | Symbol | Value | Units |
|---|------------------|-------------|-------|
| Peak Pulse Power (t _p =8/20μS) | P _{pp} | 200 | W |
| Operating Temperature | TJ | -55 to +150 | °C |
| Storage Temperature | T _{STG} | -55 to +150 | °C |

Electrical characteristics per line@25℃(unless otherwise specified)

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Units |
|------------------------------|------------------|--|------|------|------|-------|
| Peak Reverse Working Voltage | V _{RWM} | | | | 5 | V |
| Breakdown Voltage | V_{BR} | I _t = 1mA | 6.2 | | 7.2 | V |
| Reverse Leakage Current | I _R | V _{RWM} = 5V T=25°C | | | 0.5 | μA |
| Clamping Voltage | Vc | I _{PP} = 1A t _P = 8/20μs | | | 8.0 | V |
| Clamping Voltage | Vc | $I_{PP} = 5A$ $t_P = 8/20 \mu s$ | | | 10.0 | V |
| Clamping Voltage | Vc | I _{PP} =10A t _P = 8/20μs | | | 12.0 | V |
| Junction Capacitance | Cj | V _R =0V f = 1MHz | | 70 | | pF |

Typical Characteristics

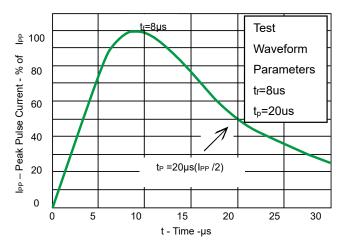


Fig 1.Pulse Waveform

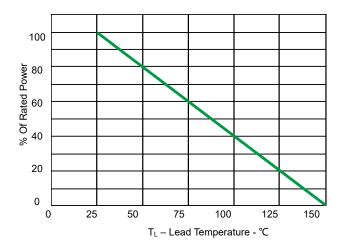
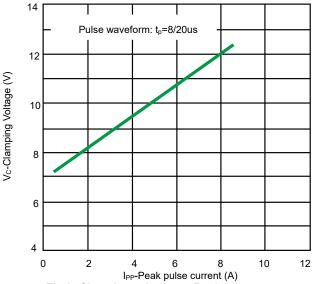


Fig 2.Power Derating Curve



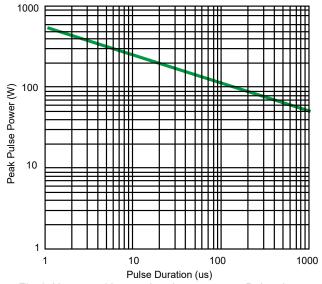
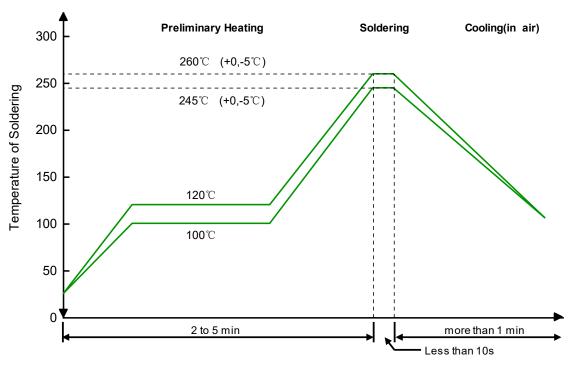


Fig 3. Clamping voltage vs. Peak pulse current

Fig 4. Non repetitive peak pulse power vs. Pulse time

Solder Reflow Recommendation



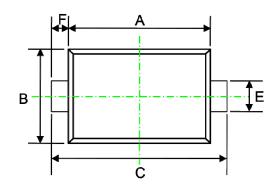
Remark: Pb free for 260°C; Pb for 245°C.

PCB Design

For TVS diodes a low-ohmic and low-inductive path to chassis earth is absolutely mandatory in order to achieve good ESD protection. Novices in the area of ESD protection should take following suggestions to heart:

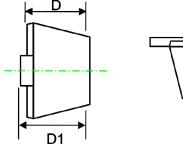
- > Do not use stubs, but place the cathode of the TVS diode directly on the signal trace.
- > Do not make false economies and save copper for the ground connection.
- Place via holes to ground as close as possible to the anode of the TVS diode.
- Use as many via holes as possible for the ground connection.
- Keep the length of via holes in mind! The longer the more inductance they will have.

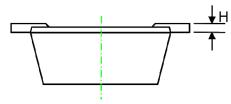
Product dimension (SOD-523)



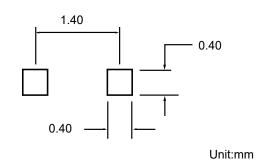
| Dim | Inches | | Millimeters | | |
|-------|------------|-------|-------------|------|--|
| Dilli | MIN | MAX | MIN | MAX | |
| Α | 0.043 | 0.051 | 1.10 | 1.30 | |
| В | 0.028 | 0.035 | 0.70 | 0.90 | |
| С | 0.059 | 0.067 | 1.50 | 1.70 | |
| D | 0.016 | 0.028 | 0.40 | 0.70 | |
| D1 | 0.016 | 0.030 | 0.41 | 0.77 | |
| Е | 0.010 | 0.014 | 0.25 | 0.35 | |
| F | 0.008 Ref. | | 0.20 | Ref. | |
| Н | 0.003 | 0.008 | 0.07 | 0.20 | |







SIDE VIEW



Suggested PCB Layout

Ordering information

| Device | Package | Shipping |
|-------------|-------------------|--------------------|
| PESDNC5D5VU | SOD-523 (Pb-Free) | 3000 / Tape & Reel |

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